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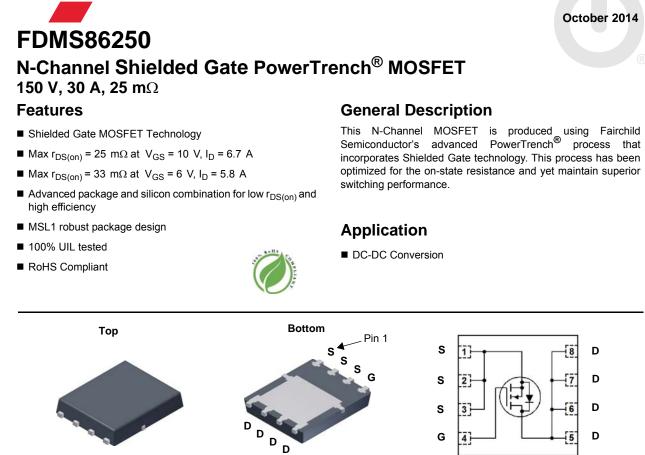


ON Semiconductor®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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Power 56

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Param	eter		Ratings	Units	
V _{DS}	Drain to Source Voltage			150	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C		30		
I _D	-Continuous	T _A = 25 °C	(Note 1a)	6.7	Α	
	-Pulsed		(Note 4)	100		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	180	mJ	
D	Power Dissipation	T _C = 25 °C		96	w	
PD	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	vv	
T _J , T _{STG}	Operating and Storage Junction Tempera	ature Range		-55 to +150	°C	

Thermal Characteristics

FAIRCHILD

ł	$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.3	°C/W	
ł	$R_{ heta JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 50	0/10	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86250	FDMS86250	Power 56	13 "	12 mm	3000 units

FDMS86250 N-Channel Shielded Gate PowerTrench $^{\textcircled{R}}$ MOSFET

	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	150			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		106		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2.0	2.9	4.0	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage		-	11		m)//°C
ΔT_{J}	Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		-11		mV/°C
r _{DS(on)}		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.7 \text{ A}$		19	25	
	Static Drain to Source On Resistance	$V_{GS} = 6 V, I_D = 5.8 A$		23	33	mΩ
-		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.7 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		35	46	0
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 6.7 A		24		S
-	Characteristics					
C _{iss}	Input Capacitance			1750	2330	pF
C _{oss}	Output Capacitance	── V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		165	220	pF
C _{rss}	Reverse Transfer Capacitance			8.8	15	pF
R _g	Gate Resistance			0.5		Ω
	a Characteristics					
Switchin	u Characterístics					
	g Characteristics			14	25	ns
t _{d(on)}	Turn-On Delay Time Rise Time	Voo = 75 V lo = 6 7 A			25 10	ns ns
t _{d(on)} t _r	Turn-On Delay Time Rise Time	V_{DD} = 75 V, I _D = 6.7 A, V _{GS} = 10 V, R _{GEN} = 6 Ω		14 4.3 22	-	_
t _{d(on)} t _r t _{d(off)}	Turn-On Delay Time	V _{DD} = 75 V, I _D = 6.7 A, V _{GS} = 10 V, R _{GEN} = 6 Ω		4.3	10	ns
t _{d(on)} t _r t _{d(off)} t _f	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		4.3 22 4.2	10 35	ns ns ns
t _{d(on)} t <u>r</u> t _{d(off)} t _f Q _g	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	V_{GS} = 10 V, R _{GEN} = 6 Ω V _{GS} = 0 V to 10 V		4.3 22	10 35 10	ns ns
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	V_{GS} = 10 V, R_{GEN} = 6 Ω		4.3 22 4.2 25	10 35 10 36	ns ns ns nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge	V_{GS} = 10 V, R_{GEN} = 6 Ω V_{GS} = 0 V to 10 V V_{GS} = 0 V to 5 V V_{DD} = 75 V,		4.3 22 4.2 25 14	10 35 10 36	ns ns nS nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	V_{GS} = 10 V, R_{GEN} = 6 Ω V_{GS} = 0 V to 10 V V_{GS} = 0 V to 5 V V_{DD} = 75 V,		4.3 22 4.2 25 14 7.4	10 35 10 36	ns ns nC nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 75 \text{ V},$ $I_D = 6.7 \text{ A}$		4.3 22 4.2 25 14 7.4 5.5	10 35 10 36 20	ns ns nC nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $I_D = 75 \text{ V},$ $I_D = 6.7 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 2 \text{ A} (\text{Note } 2)$		4.3 22 4.2 25 14 7.4 5.5	10 35 10 36 20 1.2	ns ns nC nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd} Drain-So	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 75 \text{ V},$ $I_D = 6.7 \text{ A}$		4.3 22 4.2 25 14 7.4 5.5	10 35 10 36 20	ns ns nC nC nC nC



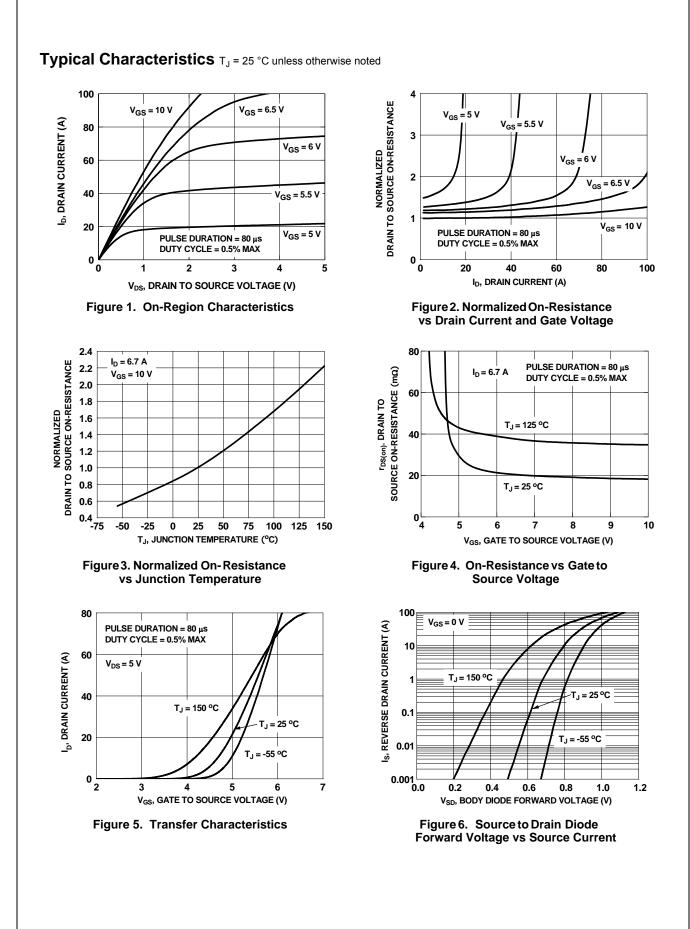
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

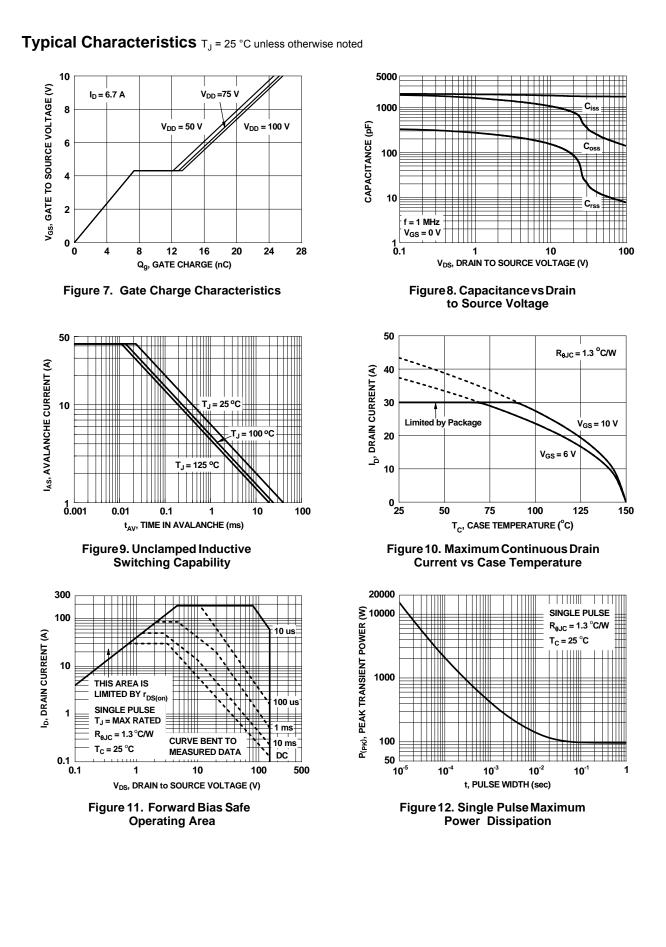
3. Starting T_J = 25 °C, L = 1 mH, I_{AS} = 19 A, V_DD = 135 V, V_GS = 10 V.

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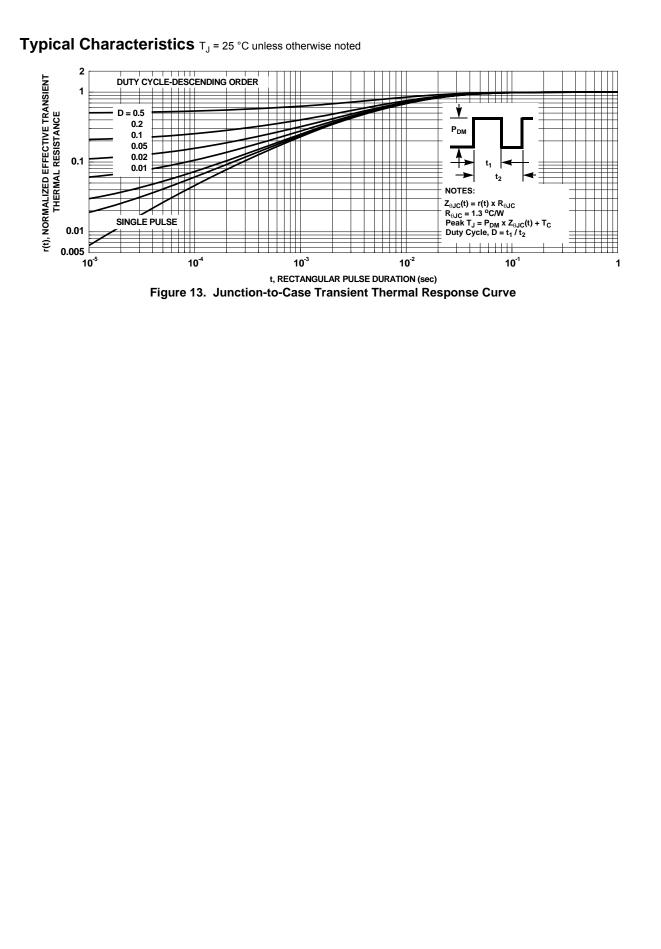
4. Pulse Id limited by junction temperature, td ≤ 100 μ s. Please refer to SOA curve for more details.

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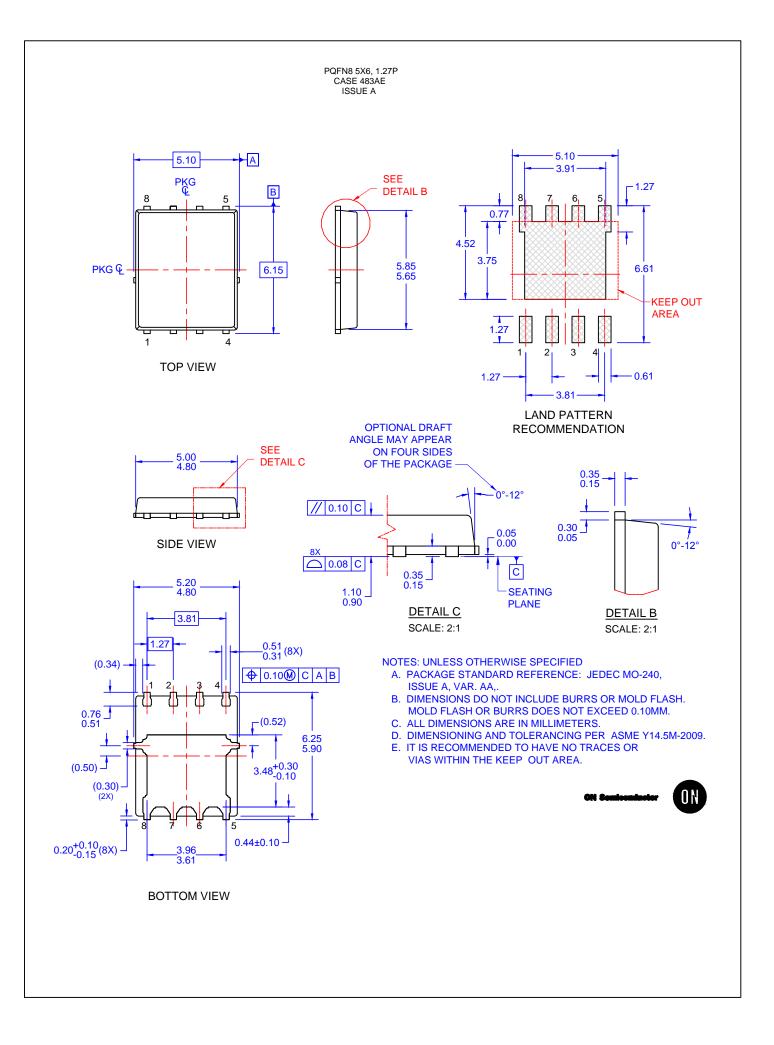




FDMS86250 N-Channel Shielded Gate PowerTrench[®] MOSFET



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